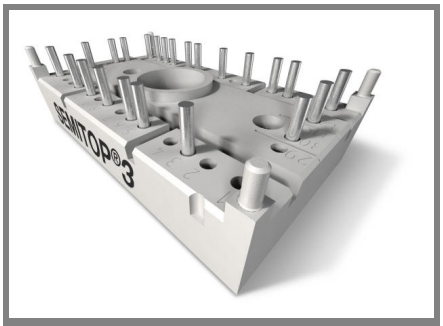
SK 60 DTA



SEMITOP® 3

3-phase bridge rectifier+ series thyristor

SK 60 DTA

Preliminary Data

Features

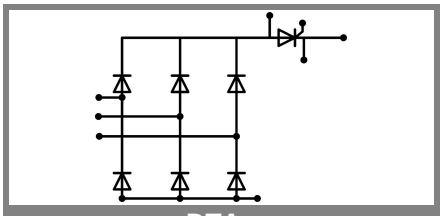
- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DBC)
- Glass passivated thyristor chips
- Reverse voltage up to 1600 V
- High surge currents

Typical Applications*

- Soft starters
- Light control
- Temperature control

V_{RSM} V	V_{RRM}, V_{DRM} V	I_D = 61 A (T_s = 80 °C)
900	800	SK 60 DTA 08
1300	1200	SK 60 DTA 12
1700	1600	SK 60 DTA 16

Characteristics		T_s= 25°C unless otherwise specified	
Symbol	**Conditions**	**Values**	**Units**
I_D	T_S = 80°C; Ind. load	61	A
I_{TAV}	sin. 180°; T_s = 25 (80) °C per thyristor	86 (49)	A
I_{FAV}	sin. 180°; T_s = 25 (80) °C per diode	65 (45)	A
I_{TSM}/I_{FSM}	T_{vj} = 25 (125) °C; 10 ms	1500 (1350)	A
I^2t	T_{vj} = 25 (125) °C; 8,3 ... 10 ms	11250 (9100)	A^2s
T_{stg}		-40,...+125	°C
T_{solder}	terminals, 10 s	260	°C
Thyristor			
$(dv/dt)_{cr}$	T_{vj} = 125 °C	1000	V/µs
$(di/dt)_{cr}$	T_{vj} = 125 °C; f = f = Hz	50	A/µs
t_q	T_{vj} = 125 °C; typ.	120	µs
I_H	T_{vj} = 25 °C; typ. / max.	100 / 200	mA
I_L	T_{vj} = 25 °C; R_G = 33 Ω; typ. / max.	200 / 500	mA
V_T	T_{vj} = 25 °C; (I_T = 200 A); max.	1,8	V
$V_{T(TO)}$	T_{vj} = 125 °C	max. 0,9	V
r_T	T_{vj} = 125 °C	max. 4,5	mΩ
I_{DD}; I_{RD}	T_{vj} = 125 °C; V_{DD} = V_{DRM}; V_{RD} = V_{RRM}	max. 20	mA
$R_{th(j-s)}$	Cont. per thyristor	0,6	K/W
T_{vj}		- 40 ... + 125	°C
V_{GT}	T_{vj} = 25 °C; d.c.	2	V
I_{GT}	T_{vj} = 25 °C; d.c.	100	mA
V_{GD}	T_{vj} = 125 °C; d.c.	0,25	V
I_{GD}	T_{vj} = 125 °C; d.c.	5	mA
Diode			
V_F	T_{vj} = 25 °C; (I_F = 75 A); max.	1,45	V
$V_{(TO)}$	T_{vj} = 125 °C	0,8	V
r_T	T_{vj} = 125 °C	4,5	mΩ
I_{RD}	T_{vj} = 125 °C; V_{RD} = V_{RRM}	2	mA
$R_{th(j-s)}$	per diode	1	K/W
T_{vj}		-40...+150	°C
Mechanical data			
V_{isol}	a. c. 50 Hz; r.m.s.; 1 s / 1 min	3000 (2500)	V
M_1	mounting torque	2,5	Nm
w		30	g
Case	SEMITOP® 3	T 45	



DTA

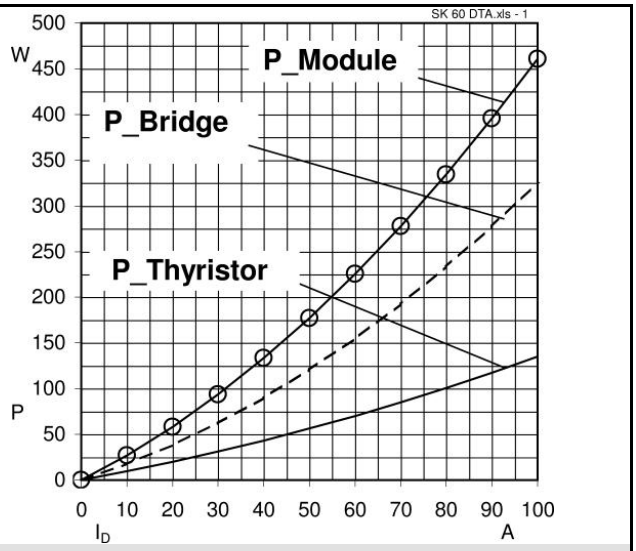


Fig. 1 Power dissipation per module vs. output bridge current

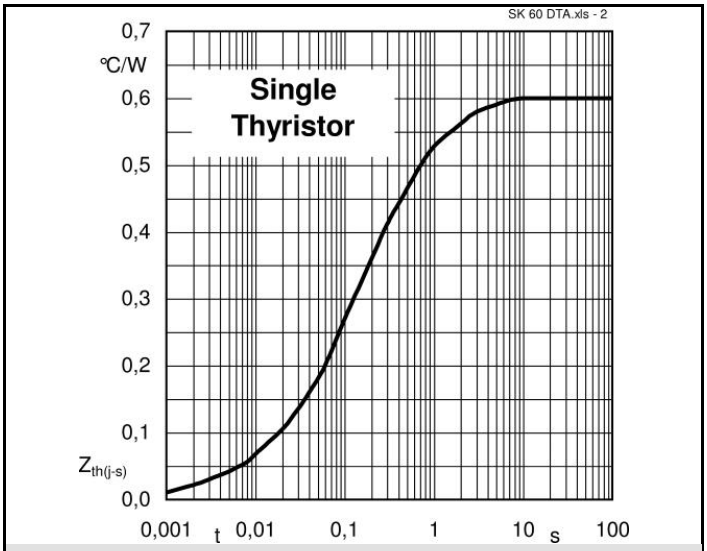


Fig. 2 Transient thermal impedance vs time

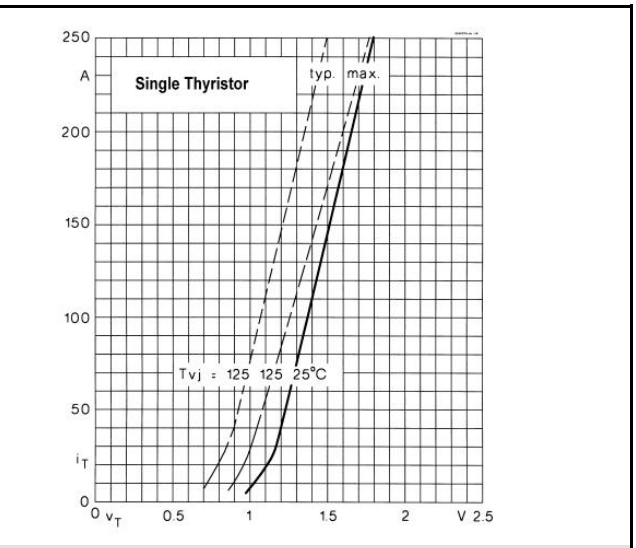


Fig. 3a Thyristor On-state characteristics

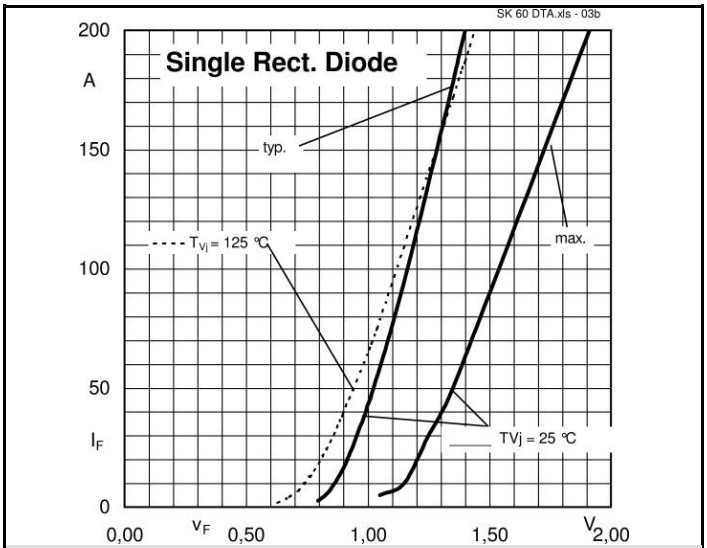


Fig. 3b Rect. Diode On-state characteristics

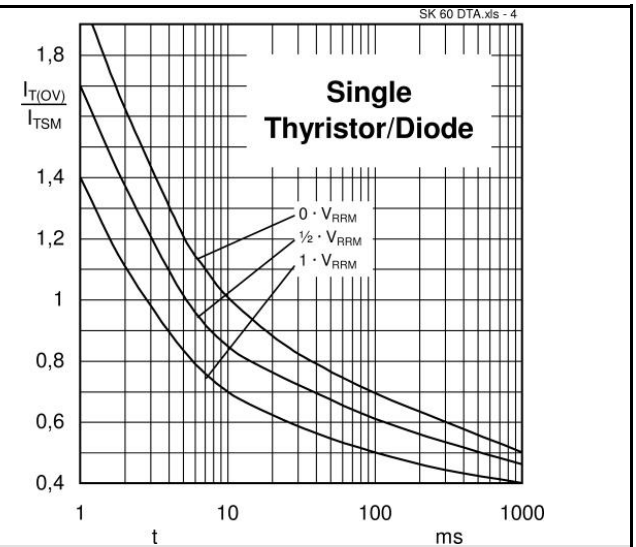


Fig. 4 Surge overload current vs. time

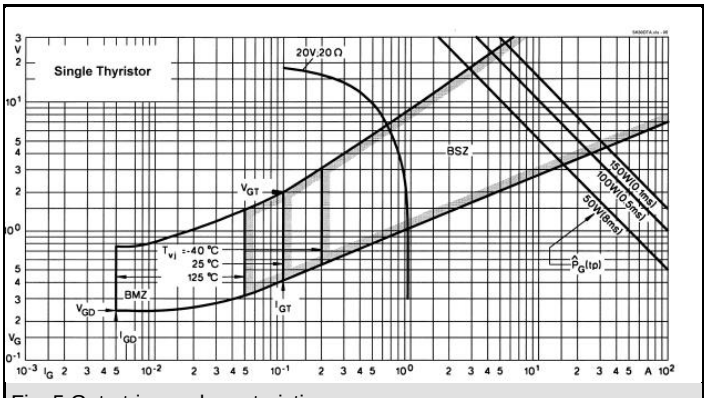
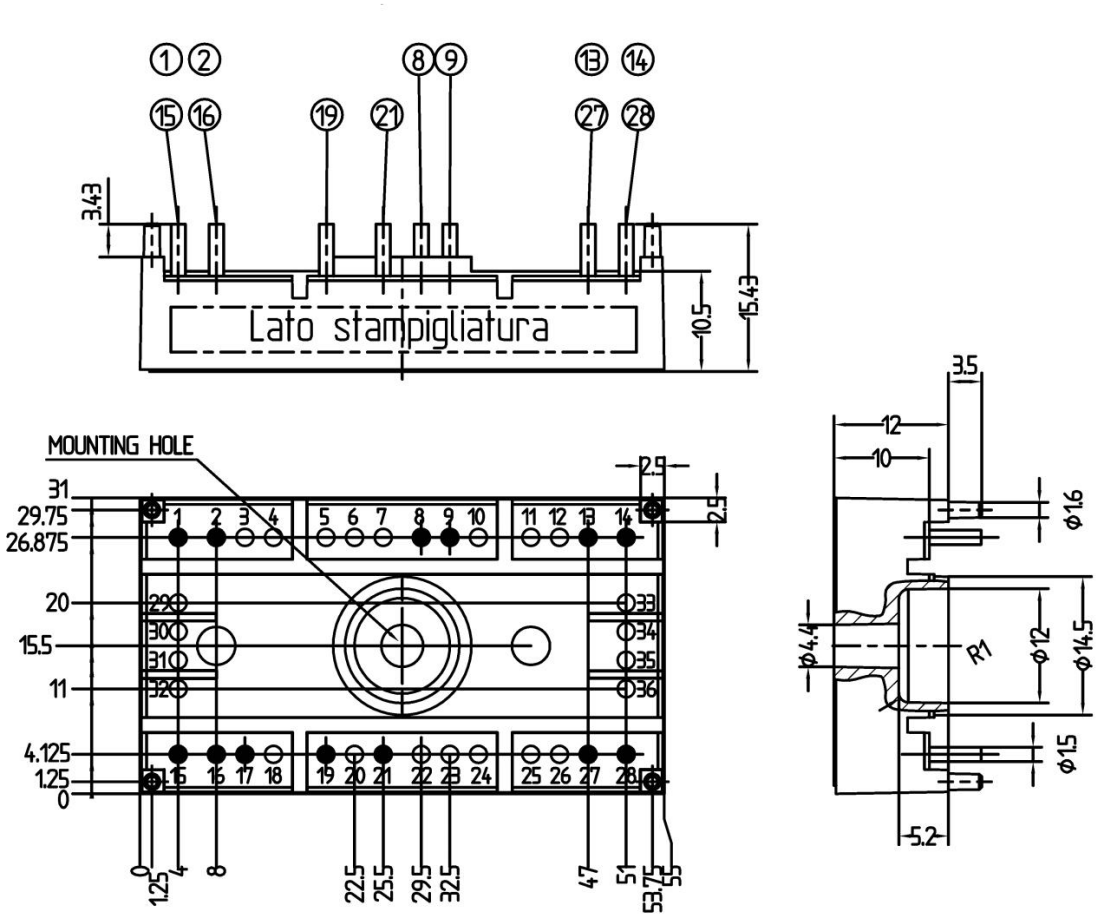


Fig. 5 Gate trigger characteristics

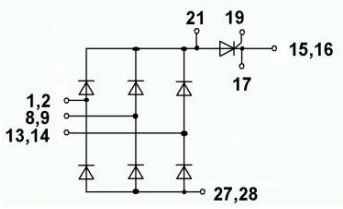
SK 60 DTA

Dimensions in mm



SUGGESTED HOLEDIAMETER FOR THE SOLDER PINS AND THE MOUNTING PINS IN THE PCB: 2 mm

Case T45 (Suggested hole diameter, in the PCB, for solder pins and plastic mounting pins: 2mm)



DTA

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

